ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INCLUSTRIES®	ckburn, Illinois. A	Il rights reserved u ntions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s encompasse	ubstances es all lowe	within the manufacture reveal materials for w	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					tion			
Supplier Information													
mpany name* Company unique ID			Unique II			ID Authority			Respon	Response Date*			
onsemi									2023-0	2023-06-08			
Contact Name	Title - Contact				Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative*	rized Representative* Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr 1	tem Number	Mfr Item Name			Effective Dat	e Version]	Manufacturing Site		Weight*	UOM	Unit Type	
NCP	CP785AH33T1G HV linear re		eg 10mA, 3.3V		2023-06-08		•	CN5		52.31	mg	Each	
Manufacturing Proccess Information					·							·	
Terminal Plating / Grid Array Material	Terminal Base Alloy		J-STD-020 MSI	L Rating	Peak Pro	rocess Body Temperature Max Time at F		re Max Time at Peal	k Temperature Numbe		ber of Reflow Cy	eles	
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy		3		260		С	30	seco	nds 3			
Comments													
ATTENTION: MSL 3 Rated item requires Bake an	d Dry Pack (afte	electrical test)											
For more information regarding material composit	on please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.74	mg	Supplier	Silicon (Si)	7440-21-3		0.74	mg
Die Attach 0.	0.14	mg	Supplier	Silver (Ag)	7440-22-4		0.105	mg
			Supplier	Epoxy resins	129915-35-1		0.035	mg
Lead Frame 22.64	22.64	mg	Supplier	Iron (Fe)	7439-89-6		0.0226	mg
			Supplier	Copper (Cu)	7440-50-8		22.6106	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0068	mg
Mold Compound-Black 2	27.94	mg		Epoxy resin	proprietary data		1.397	mg
			Supplier	Phenolic Resin	Proprietary Data		1.397	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.5588	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1397	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		24.4475	mg
Plating	0.82	mg	Supplier	Tin (Sn)	7440-31-5		0.82	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg